

**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Shigehiro NISHINO et al.

Group Art Unit: 1722

Application No.: 10/520,141

Examiner: M. SONG

Filed: September 1, 2005

Docket No.: 122261

For: LARGE-DIAMETER SIC WAFER AND MANUFACTURING METHOD THEREOF

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In reply to the June 11, 2007 Office Action, please consider the following:

**Amendments to the Claims** as reflected in the listing of claims;

**Remarks.**